



### Features

- Surface Mounting Design 7.6×5.0×5.8mm
- High Current Handling Capability 5,000A @ 8/20μs
- Low Capacitance and Insertion Loss
- Quick Response and Long Service Life
- Moisture sensitivity level: Level 1

### Application Information

- xDSL

### Agency Approvals

Icon	Description
<b>RoHS</b>	Compliance with 2011/65/EU
<b>HF</b>	Compliance with IEC61249-2-21:2003
	Mean lead free
	UL Certificated E232249

### Electrical Parameter

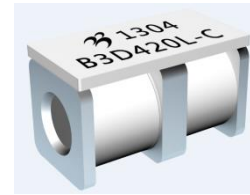
DC Breakdown Voltage 1)2)	100V/s	336-504	V
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values	≤ 950
	At 1kV/μs	Typical values of distribution	≤ 900
Impulse Discharge Current 3)	8/20μs	5,000	A
Arc Voltage	At 1A	~8	V
Insulation Resistance	DC=100V	≥1	GΩ
Capacitance at 1MHz	VDC=0.5V	≤1.5	pF
Weight		~1.1	g
Operating And Storage Temperature		-40-90	°C
Marking		Bencent Logo YY MM B3D420L-C (YY: year of production, MM: month of production)	

1) At delivery AQL 0.65 level II GB/T 2828.1-2003

2) In ionized mode

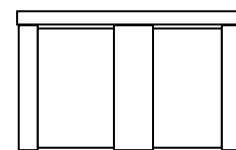
3) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21

### Exterior



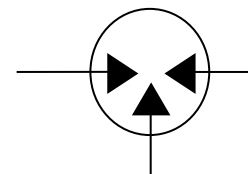
SMD

### Package (Top View)



1 2 3

### Schematic Symbol



1 2 3

Gas Discharge Tube

Version: A0 2013-09-17

**Part Numbering System**

B3D      420      L      -      C

(1)          (2)          (3)          (4)

(1) Bencent 3-Electrode SMD Gas Discharge Tube  
7.6×5.0×5.8mm

(2) DC Breakdown Voltage, e.g., 420=420V

(3) Surge Rating @8/20μs, L=5,000A (Total Impulse  
Discharge Current 5,000A @ 8/20μs)

(4) “-C” Means it is Suitable for High-Speed SMT

**Product Characteristics**

Lead Material	Copper
Body Material	Ceramics
Terminal Finish	100% Matte-Tin Plated

**Environmental Reliability Characteristics**

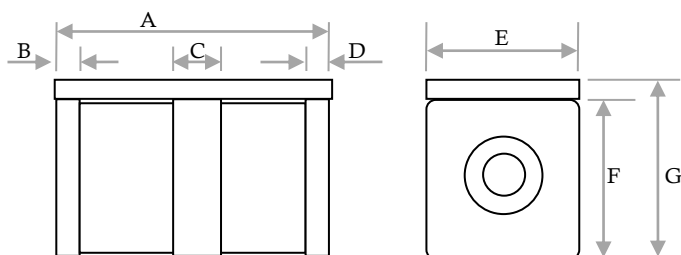
Testing items	Technical standards
High Temperature Storage Test	Temperature: 85°C Time: 2H
Low Temperature Storage Test	Temperature: -40°C Time: 2H
Vibration	Frequency: 10-500Hz Amplitude: 0.15mm Time: 45min
Resistance of soldering heat	Temperature: 260±5°C Time of dip soldering: 10s, 1time

Note: Up-screen program can be specified by customer's request via contacting Bencent service

**Solderability Test**

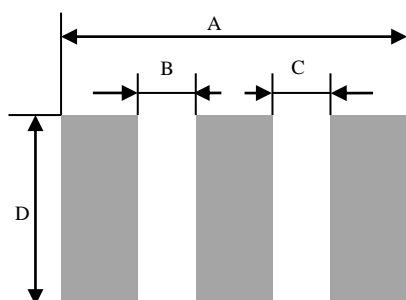
Solderability	Solder Pot Temperature:	245°C ± 5°C
	Solder Dwell Time:	4-6 seconds

**Product Dimensions**



REF	mm	inch
A	7.6±0.3	0.299±0.012
B	0.5±0.2	0.020±0.008
C	1.6±0.2	0.063±0.008
D	0.5±0.2	0.020±0.008
E	5.0±0.2	0.197±0.008
F	5.0±0.2	0.197±0.008
G	5.8±0.3	0.228±0.012

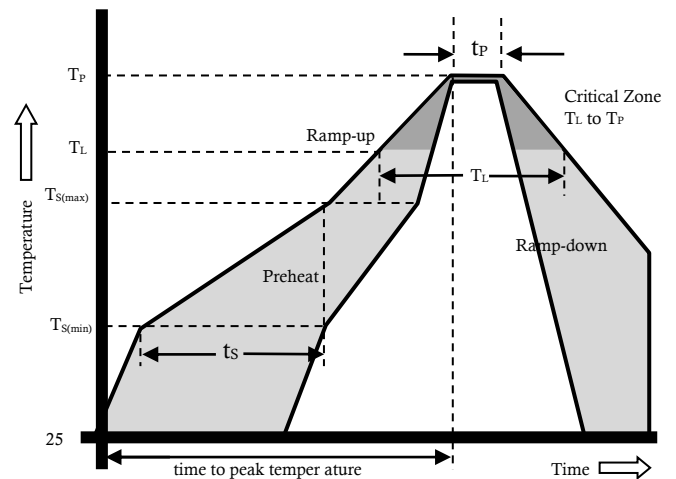
**Recommended Soldering Pad**



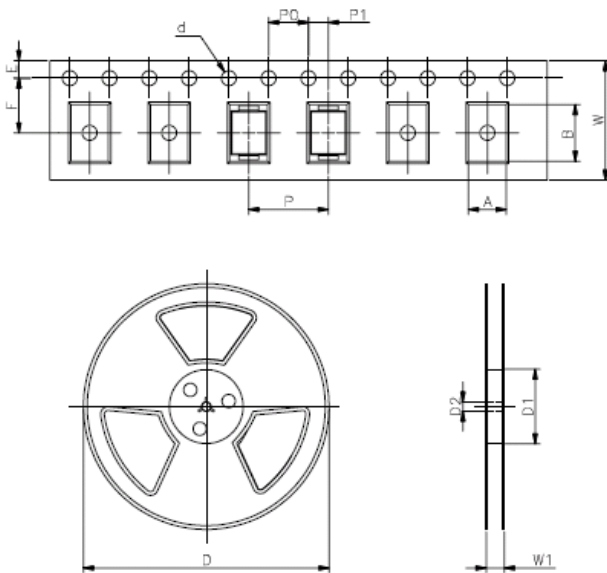
REF	mm	inch
A	9.6	0.378
B	1.5	0.059
C	1.5	0.059
D	5.0	0.197

Reflow Profile

Reflow Condition		Pb-Free assembly
Pre Heat	Temperature Min	150°C
	Temperature Max	200°C
	Time (min to max)	60 – 180 secs
Average ramp up rate (Liquids) Tmp (T <sub>L</sub> ) to peak		3°C/second max
T <sub>S</sub> (max) to T <sub>L</sub> - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T <sub>L</sub> ) (Liquids)	217°C
	- Temperature (T <sub>L</sub> )	60 – 150 seconds
Peak Temperature (T <sub>P</sub> )		260±0/-5 °C
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		~10 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T <sub>P</sub> )		8 minutes Max.
Do not exceed		260°C



Package Reel Information



REF	mm	inch
A	5.4±0.1	0.216±0.004
B	8.4±0.1	0.331±0.004
d	Φ1.5±0.1	Φ0.059±0.004
P0	4.0±0.1	0.157±0.004
P1	2.0±0.1	0.079±0.004
P	8.0±0.1	0.315±0.004
E	1.75±0.1	0.069±0.004
F	7.5±0.1	0.295±0.004
W	16.0±0.3	0.630± 0.012
D	Φ330.0	Φ13.0
D1	Φ50Min	Φ1.97Min
D2	Φ13±0.15	0.512±0.006
W1	16.8±2.0	0.661±0.079

Outline	Reel (PCS)	Per Carton (PCS)	Reel Diameter (mm)	Carton Size(mm)		
				L	W	H
TAPING	1,000	16,000	330	360	360	380

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for* [Gas Discharge Tubes - GDTs / Gas Plasma Arrestors](#) *category:*

*Click to view products by* [Bencent](#) *manufacturer:*

Other Similar products are found below :

[PMT1023004](#) [PMT1025001](#) [RF3161-000](#) [PMT1035004](#) [PMT1040004](#) [PMT809006](#) [CG2250](#) [CG2800](#) [CG31.5L](#) [GT-SMD181240012-TR](#)  
[WPGT-2N145B6L](#) [WPGT-2N230B6L](#) [WPGT-2N470B6L](#) [WPGT-2R470B6L](#) [WPGT-2RM230A6L](#) [WPGT-2RM350A6L](#) [WPGT-](#)  
[2RM70A6L](#) [WPGT-2RM90A6L](#) [WPGT-2S145](#) [WPGT-2S350](#) [WPGT-2S470](#) [WPGT-3R350CF](#) [WPGT-3R350G1](#) [WPGT-3R90G1](#) [WPGT-](#)  
[3R75G1](#) [WPGT-3R470G1](#) [WPGT-3R250C](#) [WPGT-3R230G1](#) [WPGT-2S230](#) [WPGT-2RM470A6L](#) [WPGT-2RM145A6L](#) [WPGT-2R3000B8L](#)  
[WPGT-2R2700B8L](#) [WPGT-2R1000B8L](#) [WPGT-2N90B6L](#) [WPGT-2N70B6L](#) [WPGT-2N350B6L](#) [WPGT-2N230B6L1](#) [CG90](#) [CG2230](#)  
[CG2145](#) [CG21000](#) [GT-SMD181215012-TR](#) [9071.99.0547 \(73\\_Z-0-0-547\)](#) [B88069X6940B152](#) [V20-1+NPE-280](#) [V20-3+NPE+FS-280](#)  
[SD09-V24 9](#) [C50-0-255](#) [SG24PA300](#)